

Silicon PIN Photodiode

Description

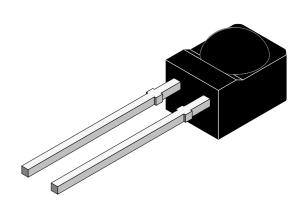
BPV23F is a high speed and high sensitive PIN photodiode in a plastic package with a spherical side view lens. The epoxy package itself is an IR filter, spectrally matched to GaAs or GaAs/GaAlAs IR emitters ($\lambda_p = 950 \text{ nm}$).

Lens radius and chip position are perfectly matched to the chip size, giving high sensitivity without compromising the viewing angle.

In comparison with flat packages the lens package achieves a sensitivity improvement of 80%.

Features

- Large radiant sensitive area $(A = 5.7 \text{ mm}^2)$
- Wide viewing angle $\varphi = \pm 60^{\circ}$
- Improved sensitivity
- Fast response times
- Low junction capacitance
- Plastic package with IR filter
- Filter designed for 950 nm transmission



94 8633

Applications

Infrared remote control and free air transmission systems in combination with IR emitter diodes (TSU...– or TSI...–Series).

Absolute Maximum Ratings

 $T_{amb} = 25^{\circ}C$

Parameter	Test Conditions	Symbol	Value	Unit
Reverse Voltage		V_{R}	60	V
Power Dissipation	$T_{amb} \leq 25 ^{\circ}C$	P_{V}	215	mW
Junction Temperature		Tj	100	°C
Operating Temperature Range		T _{amb}	-55+100	°C
Storage Temperature Range		T _{stg}	-55+100	°C
Soldering Temperature	t ≤ 5 s	T_{sd}	260	°C
Thermal Resistance Junction/Ambient		R _{thJA}	350	K/W

BPV23F



Basic Characteristics

 $T_{amb}=25\,^{\circ}C$

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Forward Voltage	$I_F = 50 \text{ mA}$	V_{F}		1	1.3	V
Breakdown Voltage	$I_R = 100 \mu A, E = 0$	V _(BR)	60			V
Reverse Dark Current	$V_R = 10 \text{ V, } E = 0$	I _{ro}		2	30	nA
Diode Capacitance	$V_R = 0 \text{ V, } f = 1 \text{ MHz, } E = 0$	C_{D}		48		pF
Serial Resistance	$V_R = 12 \text{ V, f} = 1 \text{ MHz}$	R_S		900		Ω
Open Circuit Voltage	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	V _o		390		mV
Temp. Coefficient of Vo	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	TK_{Vo}		-2.6		mV/K
Short Circuit Current	$E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$	I_k		60		μΑ
Reverse Light Current	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}, \ V_R = 5 \text{ V}$	I_{ra}	45	63		μΑ
Temp. Coefficient of I _{ra}	$E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}, \ V_R = 10 \text{ V}$	TK _{Ira}		0.2		%/K
Absolute Spectral Sensitivity	$V_R = 5 \text{ V}, \lambda = 870 \text{ nm}$	s(\(\lambda\)		0.35		A/W
	$V_R = 5 \text{ V}, \lambda = 950 \text{ nm}$	s(\lambda)		0.6		A/W
Angle of Half Sensitivity		φ		±60		deg
Wavelength of Peak Sensitivity		$\lambda_{ m p}$		950		nm
Range of Spectral Bandwidth		$\lambda_{0.5}$		8701050		nm
Quantum Efficiency	$\lambda = 950 \text{ nm}$	η		90		%
Noise Equivalent Power	V _R =10V, λ=950nm	NEP		$4x10^{-14}$		W/√ Hz
Detectivity	V _R =10V, λ=950nm	D*		5x10 ¹²		cm√Hz/ W
Rise Time	$V_R=10V$, $R_L=1k\Omega$, $\lambda=820$ nm	t _r		70		ns
Fall Time	$V_R=10V$, $R_L=1k\Omega$, $\lambda=820$ nm	t_{f}		70		ns
Cut-Off Frequency	$V_R=12V$, $R_L=1k\Omega$, $\lambda=870$ nm	f_c		4		MHz
	V_R =12V, R_L =1kΩ, λ =950nm	f_c		1		MHz

Typical Characteristics ($T_{amb} = 25$ °C unless otherwise specified)

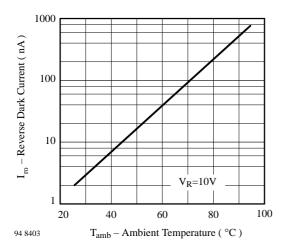


Figure 1. Reverse Dark Current vs. Ambient Temperature

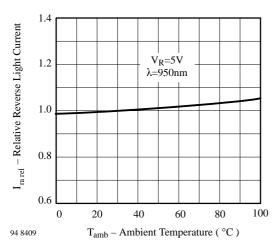


Figure 2. Relative Reverse Light Current vs.
Ambient Temperature

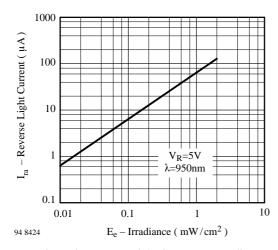


Figure 3. Reverse Light Current vs. Irradiance

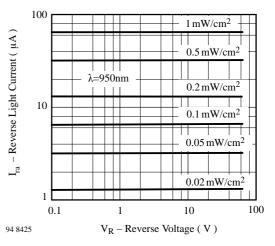


Figure 4. Reverse Light Current vs. Reverse Voltage

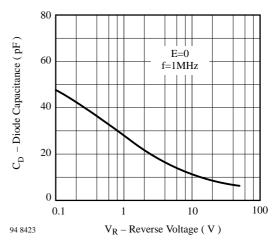


Figure 5. Diode Capacitance vs. Reverse Voltage

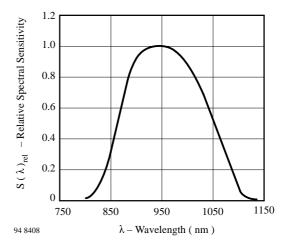


Figure 6. Relative Spectral Sensitivity vs. Wavelength



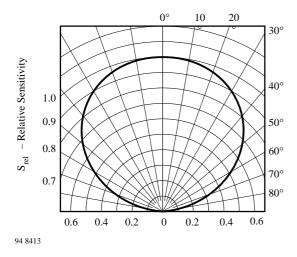
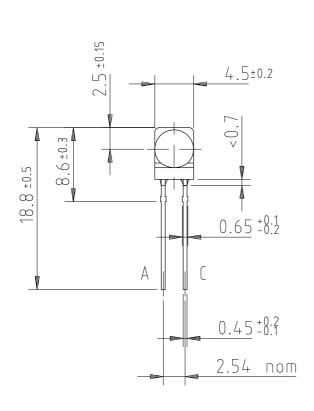
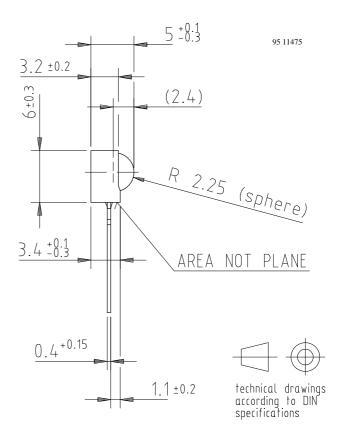


Figure 7. Relative Radiant Sensitivity vs. Angular Displacement

Dimensions in mm







Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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